

FCP170N60 N-Channel SuperFET[®] II MOSFET

600 V, 22 A, 170 m Ω

Features

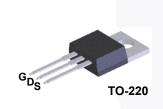
- 650 V @T_J = 150°C
- Typ. R_{DS(on)} = 150 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 42 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 190 pF)
- 100% Avalanche Tested
- RoHS Compliant

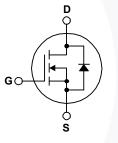
Applications

- Telecom / Sever Power Supplies
- Industrial Power Supplies
- AC-DC Power Supply

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCP170N60	Unit			
V _{DSS}	Drain to Source Voltage	in to Source Voltage				
V _{GSS}	Cata ta Sauraa Maltaga	- DC		±20	V	
	Gate to Source Voltage	- AC		±30	- V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		22	А	
	Drain Current	- Continuous (T _C = 100 ^o C)		14	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	66	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			525	mJ	
I _{AR}	Avalanche Current	(Note 1)	5	А		
E _{AR}	Repetitive Avalanche Energy	(Note 1)	2.27	mJ		
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt			20		
P _D	Rower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		227	W	
	Power Dissipation	- Derate above 25°C		1.82	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
Τ _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

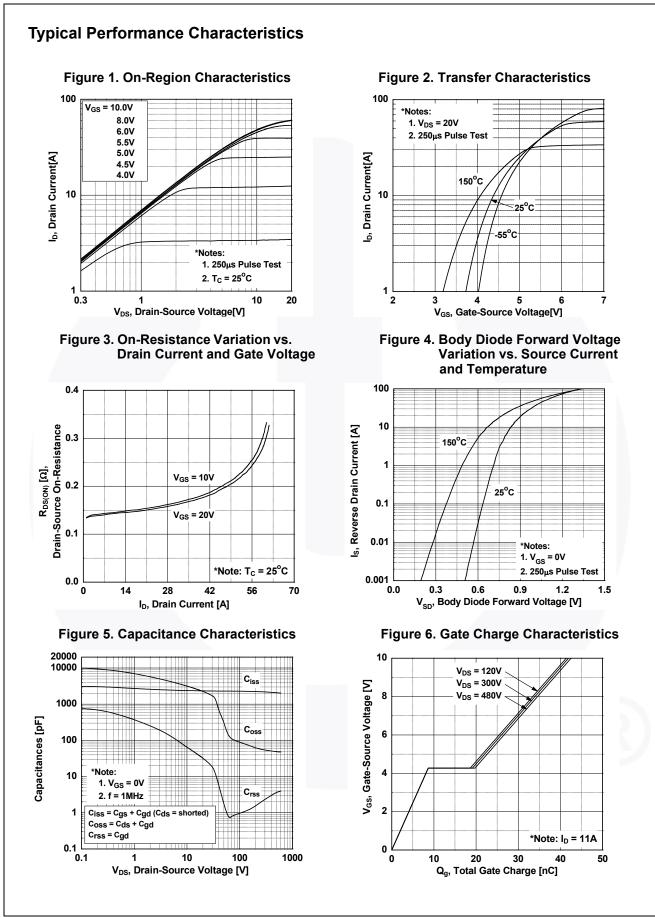
Symbol	Parameter	FCP170N60	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.55	°C/W	
R_{\thetaJA}	nermal Resistance, Junction to Ambient, Max. 40			

September 2014

Part N			Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity
FCP17			TO-220	D Tube N/A		N/A		50 units	
Electric	al Char	racteristics T _c	= 25ºC unless	otherwise noted.					
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Chara	cteristic	S							
	Drain to Source Breakdown Voltage			I _D = 10 mA,V _{GS} = 0 V,T _J = 25°C		600	-	-	V
BV _{DSS}			Voltage	I _D = 10 mA,V _{GS} = 0 V, T _J = 150°C		650	-	-	V
ΔΒV _{DSS} / ΔΤ _J		Breakdown Voltage Temperature Coefficient		$I_D = 10$ mA, Referenced to $25^{\circ}C$		-	0.67	-	V/ºC
I =	Zoro Coto Voltago Droin Current		rent	V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	
I _{DSS} Zer		Zero Gate Voltage Drain Current		V _{DS} = 480 V, V _{GS} = 0 V,T _C = 125 ^o C		-	1.2	-	μA
I _{GSS}	Gate to	Body Leakage Curre	nt	V_{GS} = ±20 V, V_{DS} = 0	V	-	-	±100	nA
On Chara	cteristic	s							
V _{GS(th)}	Gate T	hreshold Voltage		$V_{GS} = V_{DS}, I_{D} = 250 \mu$	ιA	2.5	-	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance		sistance	V _{GS} = 10 V, I _D = 11 A		-	150	170	mΩ
9 _{FS}	Forwar	Forward Transconductance		V_{DS} = 20 V, I_{D} = 11 A		-	17	-	S
Dynamic	Charact	eristics							
C _{iss}	Input Capacitance					-	2150	2860	pF
C _{oss}	Output	Capacitance		V _{DS} = 380 V, V _{GS} = 0 V f = 1 MHz		-	60	80	pF
C _{rss}	Revers	e Transfer Capacitano	e			-	2.65	-	pF
C _{oss (eff.)}	Effectiv	Effective Output Capacitance		$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	190	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V		$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 11 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	42	55	nC
Q _{gs}	Gate to	Source Gate Charge				-	9	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge				-	11	-	nC
ESR	Equival	Equivalent Series Resistance		f = 1 MHz		-	0.95	-	Ω
Switching	g Charac	teristics							
t _{d(on)}	Turn-O	On Delay Time				-	21	50	ns
t _r		n Rise Time		V_{DD} = 380 V, I _D = 11 A, V_{GS} = 10 V, R _g = 4.7 Ω (Note 4)		-	12	35	ns
t _{d(off)}	Turn-Of	f Delay Time				-	55	120	ns
t _f	Turn-Of	ff Fall Time				-	3.8	18	ns
Drain-Sou	urce Dio	de Characteristi	cs						
I _S		m Continuous Drain t		e Forward Current		-	-	22	Α
I _{SM}	Maximum Pulsed Drain to Source Diode F					-	-	66	Α
V _{SD}	Drain to	Drain to Source Diode Forward Voltage		V _{GS} = 0 V, I _{SD} = 11 A		-	-	1.2	V
	Reverse	e Recovery Time	-	$V_{GS} = 0 V, I_{SD} = 11 A,$ $dI_F/dt = 100 A/\mu s$		-	346	-	ns
t _{rr}		e Recovery Charge					6.2	1	μC

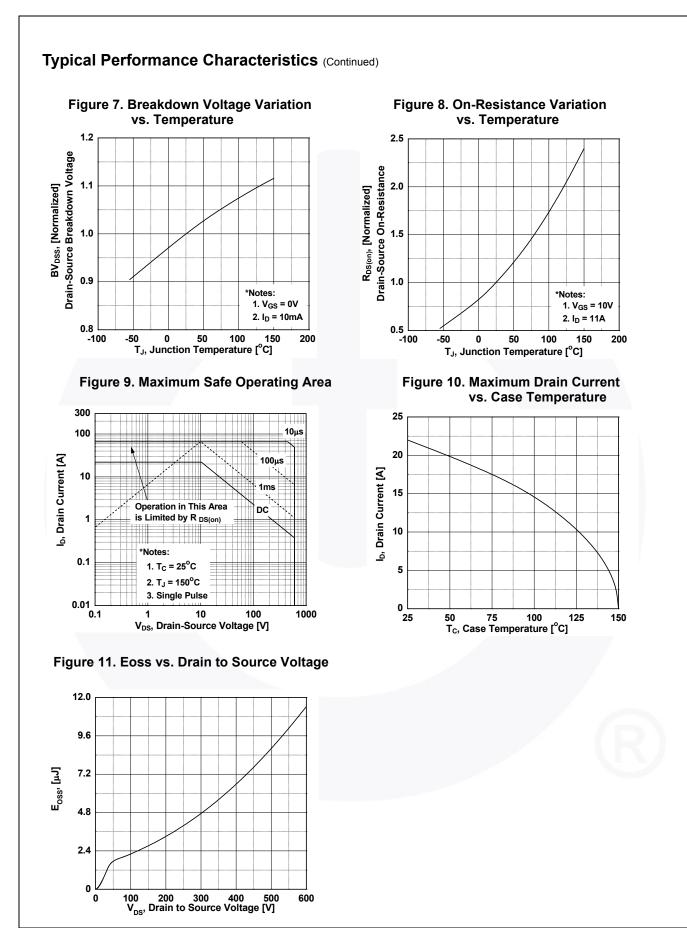
2. I_{AS} = 5 A, R_G = 25 Ω , Starting T_J = 25°C

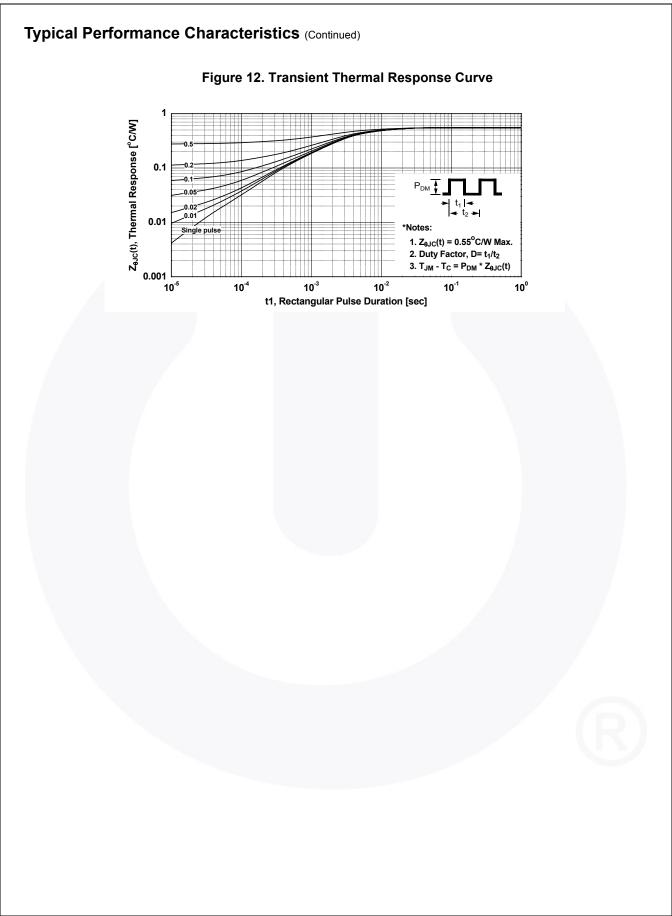
3. I_{SD} \leq 11 A, di/dt \leq 200 A/µs, V_{DD} \leq 380 V, Starting T_J = 25°C 4. Essentially independent of operating temperature typical characteristics FCP170N60 — N-Channel SuperFET[®] II MOSFET

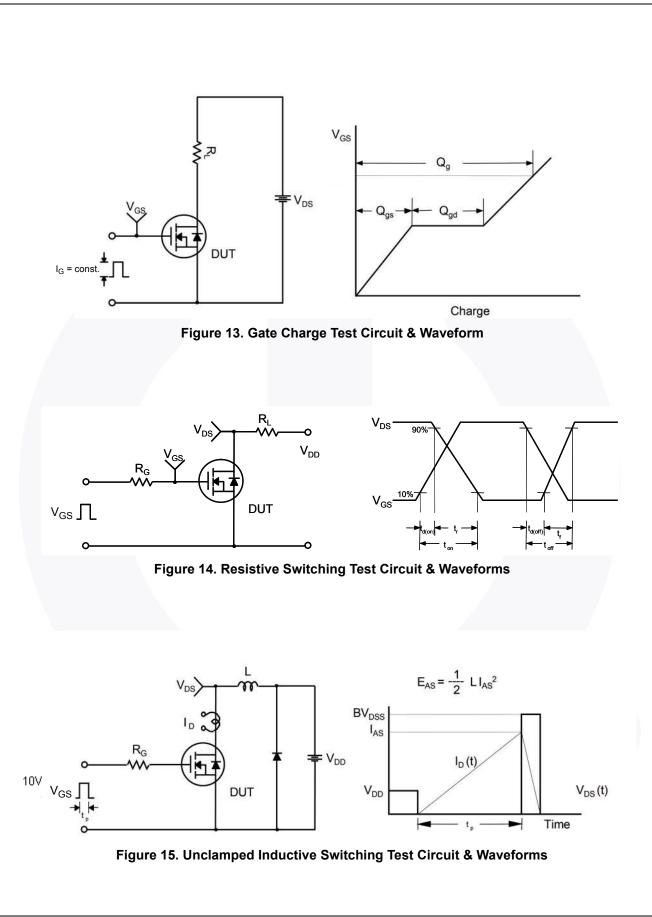


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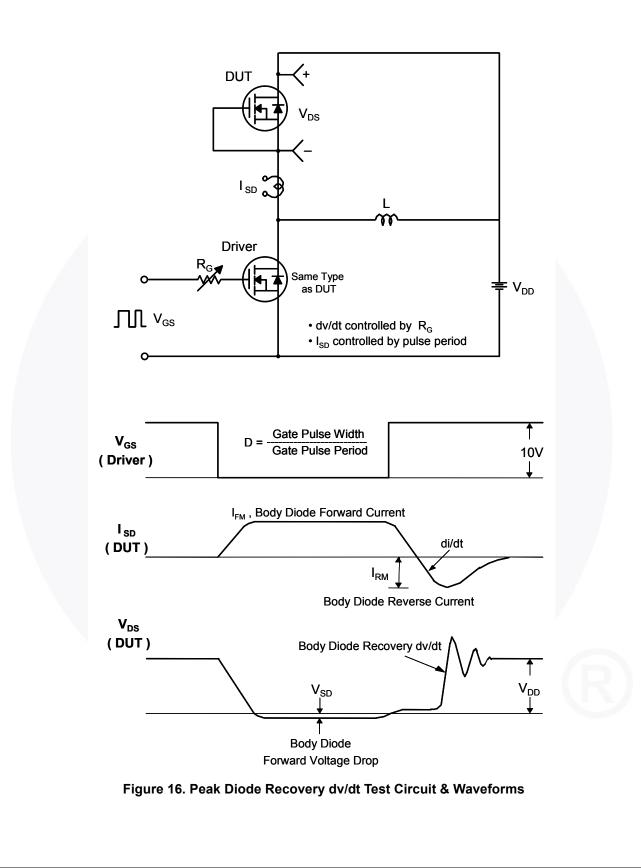


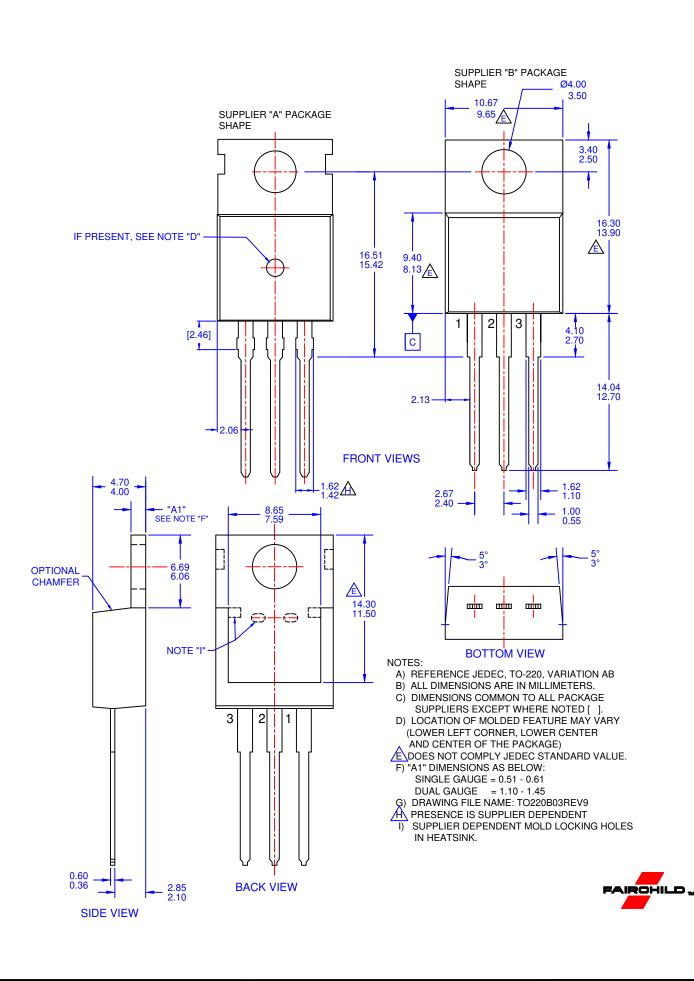


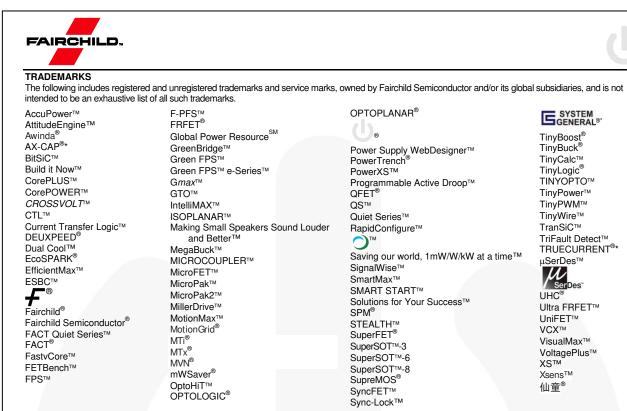


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